MOSFETs Silicon N-Channel MOS (π-MOSⅧ)

TK4A80E

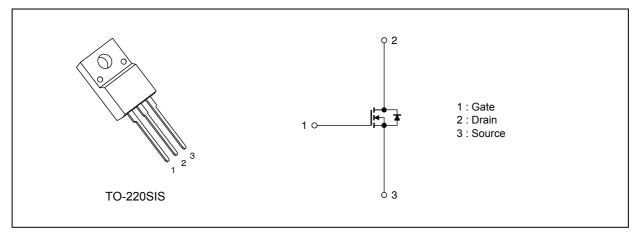
1. Applications

• Switching Voltage Regulators

2. Features

- (1) Low drain-source on-resistance : $R_{DS(ON)} = 2.8 \Omega$ (typ.)
- (2) Low leakage current : $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 640 \ V)$
- (3) Enhancement mode : V_{th} = 2.5 to 4.0 V (V_{DS} = 10 V, I_{D} = 0.4 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25 \,^{\circ}C$ unless otherwise specified)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	800	V
Gate-source voltage		V _{GSS}	±30	
Drain current (DC)	(Note 1)	I _D	4.0	A
Drain current (pulsed)	(Note 1)	I _{DP}	12	
Power dissipation (T	_c = 25 °C)	PD	35	W
Single-pulse avalanche energy	(Note 2)	E _{AS}	152	mJ
Avalanche current		I _{AR}	4.0	A
Reverse drain current (DC)	(Note 1)	I _{DR}	4.0	
Reverse drain current (pulsed)	(Note 1)	I _{DRP}	12	
Channel temperature		T _{ch}	150	°C
Storage temperature		T _{stg}	-55 to 150	
Isolation voltage (RMS) (t = 1.0 s)	V _{ISO(RMS)}	2000	V
Mounting torque		TOR	0.6	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

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5. Thermal Characteristics

Characteristics		Max	Unit
Channel-to-case thermal resistance	R _{th(ch-c)}	3.57	°C/W
Channel-to-ambient thermal resistance	R _{th(ch-a)}	62.5	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: V_{DD} = 90 V, T_{ch} = 25 °C (initial), L = 17.3 mH, R_G = 25 Ω , I_{AR} = 4.0 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics (Ta = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	_	_	±1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 640 V, V _{GS} = 0 V	_	—	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	800	—	_	V
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 0.4 mA	2.5	_	4.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 2.0 A		2.8	3.5	Ω

6.2. Dynamic Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V,		650	_	pF
Reverse transfer capacitance	C _{rss}	f = 1 MHz		6	_	
Output capacitance	C _{oss}		_	55	_	
Gate resistance	r _g	V _{DS} = OPEN, f = 1 MHz	_	5.0	_	Ω
Switching time (rise time)	t _r	See Fig.6.2.1		25	_	ns
Switching time (turn-on time)	t _{on}		_	55	_	
Switching time (fall time)	t _f		_	15	_	
Switching time (turn-off time)	t _{off}			75	_	
MOSFET dv/dt ruggedness	dv/dt	V_{DD} = 0 to 400 V, I _D = 4.0 A	10	_	_	V/ns

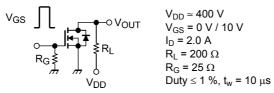


Fig. 6.2.1 Switching Time Test Circuit

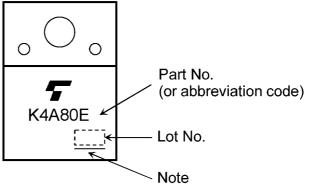
6.3. Gate Charge Characteristics (Ta = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 400 \text{ V}, \text{ V}_{GS}$ = 10 V,	—	15	—	nC
Gate-source charge 1	Q _{gs1}	$I_{\rm D} = 4.0 {\rm A}$	_	5	—	
Gate-drain charge	Q _{gd}			7	_	

6.4. Source-Drain Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	V _{DSF}	I _{DR} = 4.0 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 4.0 A, V _{GS} = 0 V,	_	900	—	ns
Reverse recovery charge	Q _{rr}	-dI _{DR} /dt = 100 A/μs	_	5	—	μC
Peak reverse recovery current	l _{rr}			16	_	А

7. Marking (Note)

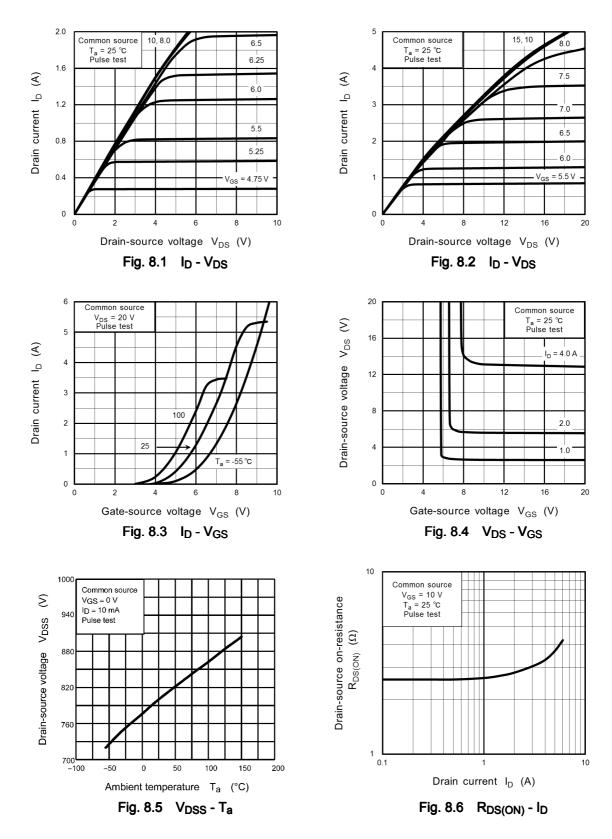




Note: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]] Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

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8. Characteristics Curves (Note)



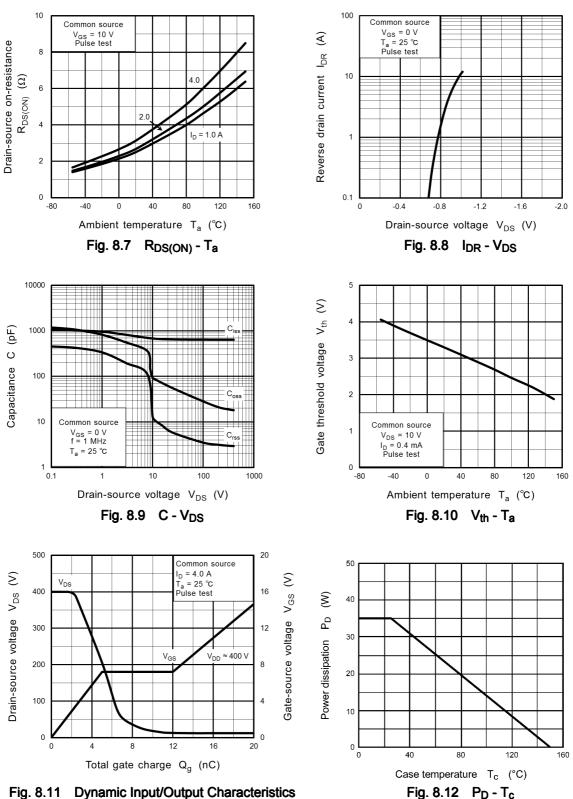
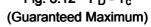
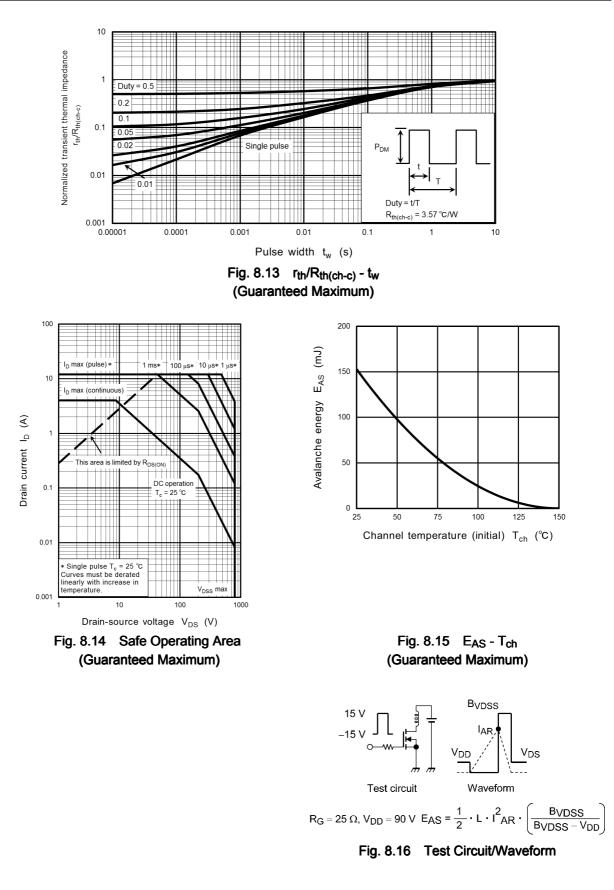


Fig. 8.11 Dynamic Input/Output Characteristics

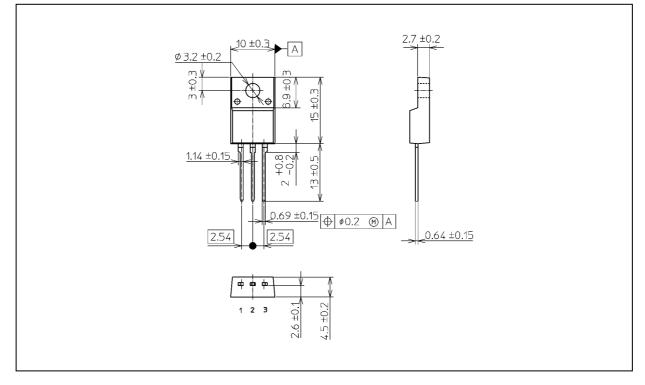




Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1.7 g (typ.)

	Package Name(s)
TOSHIBA: 2-10U1S	
Nickname: TO-220SIS	

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